

CLAIM AMENDMENTS

- 9067
1. (Currently amended) A tamper evident RFID tag, comprising:
a tamper evident label material, with
an adhesive on a back side, and
an RFID Transponder adhered to said adhesive, wherein:
the tamper evident label material is a vinyl with a tensile and tear resistance such that the tamper evident label material one of tears and breaks upon an attempted removal from a substrate.
 2. (Cancelled)
 - 9067 3. (Original) The tag of claim 1, wherein:
the tamper evident label material is 3M 7610 ScotchMark Destructible Vinyl.
 4. (Original) The tag of claim 1, further including:
a release liner attached to said adhesive.
 - Q1 cont. 5. (Original) The tag of claim 1, further including:
a hologram on the label material.
 6. (Original) The tag of claim 1, further including:
microprinting on the label material.
 7. (Currently amended) A tamper evident RFID tag, comprising
a clear label material, with
a silicone pattern and an a pigmented adhesive on a back side, and
an RF transponder adhered to said adhesive;
wherein separation of the tag from a substrate results in incomplete separation of
the adhesive in the form of the silicone pattern and said pattern becomes visible.
 8. (Original) The tag of claim 7, wherein:
the tamper evident label material is one of 3M 7866, 3M 7389 and 3M 7385.

9. (Original) The tag of claim 8, further including:
a hologram on the label material.
10. (Currently amended) The tag of claim 9 ~~8~~, further including:
microprinting on the label material.
11. (Currently amended) A tamper evident RF transponder, comprising
a base film with a printed antenna and an integrated circuit chip on a front surface;
the base film having ~~propagation~~ tear cuts at one or more edges of the base film
whereby attempted removal of the RF transponder from a substrate causes the ~~propagation~~
tear cuts to expand and to sever a connection between the printed antenna and the
integrated circuit chip.
12. (Cancelled)
13. (Currently amended) ~~40~~ The method of claim ~~12~~ 21, further including the step of:
applying a release liner to the adhesive.
14. (New) The tag of claim 3, further including:
a release liner attached to said adhesive.
15. (New) The tag of claim 3, further including:
a hologram on the label material.
16. (New) The tag of claim 3, further including:
microprinting on the label material.
17. (New) The tag of claim 8, further including:
a release liner attached to said adhesive.
18. (New) The tag of claim 7, further including:
a release liner attached to said adhesive.

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19. (New) The tag of claim 7, further including:
a hologram on the label material.
20. (New) The tag of claim 7, further including:
microprinting on the label material.
21. (New) A method of fabricating a tamper evident RFID tag, comprising the steps of:
embedding the RFID transponder of claim 11 into a label material, and applying an
adhesive to a backside of the label material.
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